



Vishay Siliconix

N-Channel 60 V (D-S) MOSFET

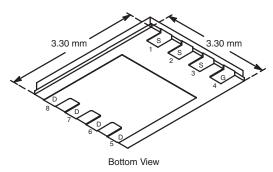
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
60	0.021 at V _{GS} = 10 V	9.5			
	0.031 at V _{GS} = 4.5 V	7.9			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_q Tested
- 100 % UIS Tested
 - Compliant to RoHS Directive 2002/95/EC



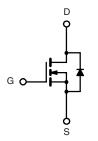
PowerPAK® 1212-8



Ordering Information: Si7120ADN-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- · Primary Side Switch
- Synchronous Rectification



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	• 1 _A – 25 °C, unites				
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	60		V
Gate-Source Voltage		V _{GS}			
Continuous Dunin Comment /T 450 °C\	T _A = 25 °C		9.5	6.0	
Continuous Drain Current (T _J = 150 °C)	T _A = 70 °C	l _D	7.6	4.8	
Pulsed Drain Current		I _{DM}	40		Α
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3	
Single Avalanche Current	L = 0.1 mH	I _{AS}	22		
Single Avalanche Energy	L=0.11IIII	L = 0.1 mH E _{AS}		24	
Maximum Power Dissipation ^a	T _A = 25 °C	В	3.8	1.5	W
	T _A = 70 °C	P _D	2.4	1.0	, vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b, c}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	26	33		
	Steady State		65	81	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4		

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See solder profile (www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

Si7120ADN

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions M		Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.5	2.5	3.0	V		
Gate Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	μА		
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C			5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 9.5 A		0.0175	0.021			
		$V_{GS} = 4.5 \text{ V}, I_D = 7.9 \text{ A}$		0.025	0.031	Ω		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 9.5 A		35		S		
Diode Forward Voltage ^a	V_{SD}	I _S = 3.2 A, V _{GS} = 0 V		0.78	1.2	V		
Dynamic ^b								
Total Gate Charge	Q_g			30	45	nC		
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 9.5 \text{ A}$		6.9				
Gate-Drain Charge	Q_{gd}			5.8		1		
Gate Resistance	R_{g}		0.65	1.3	1.95	Ω		
Turn-On Delay Time	t _{d(on)}			14	25			
Rise Time	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 30 \Omega$		12	20	ns		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		50	80			
Fall Time	t _f			12	20			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.2 A, dl/dt = 100 A/μs		60	100			

Notes:

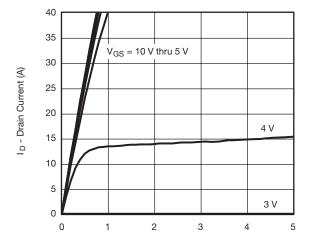
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



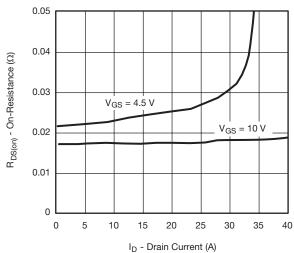
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

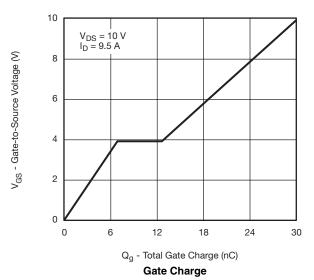


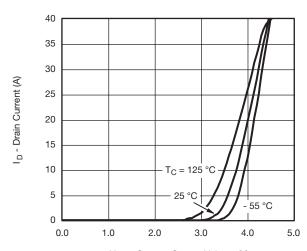
V_{DS} - Drain-to-Source Voltage (V)



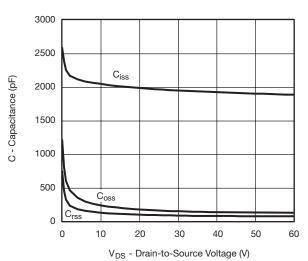


On-Resistance vs. Drain Current

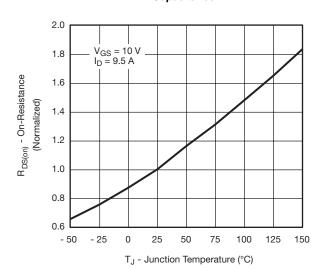




V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



Capacitance



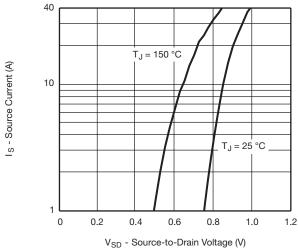
On-Resistance vs. Junction Temperature

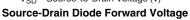
Si7120ADN

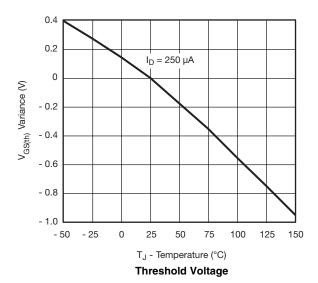
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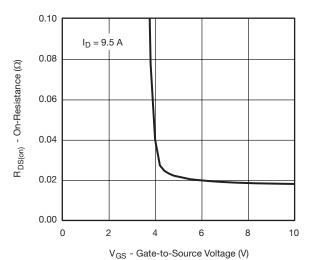
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

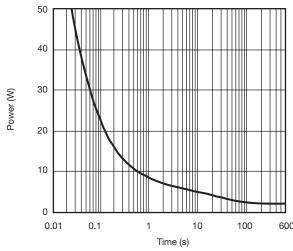




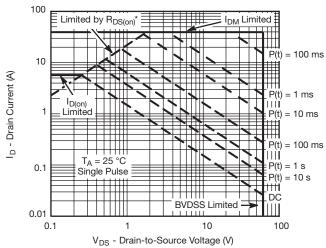




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



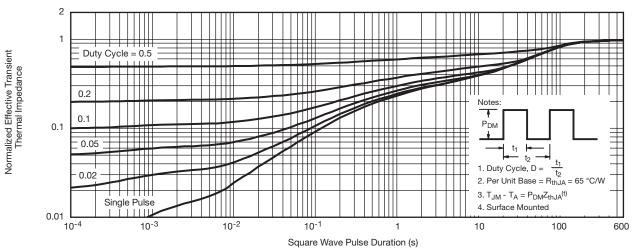
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area

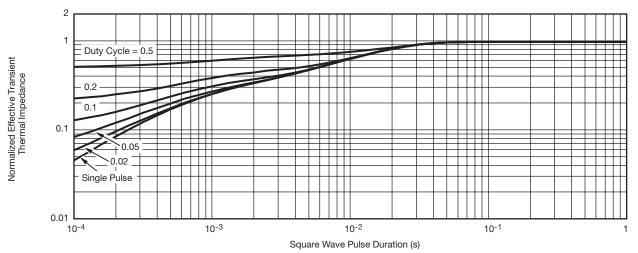


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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